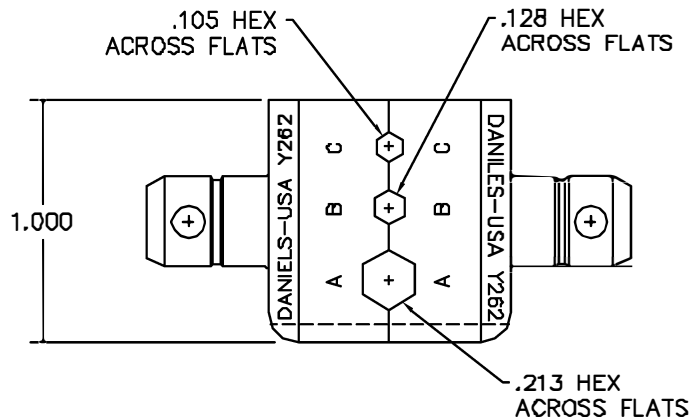



REVISIONS				
REV. SYM.	E.C.O. NUMBER	DESCRIPTION	BY DATE	APP'D DATE
1		ORIGINAL RELEASE	LSV 4/24/88	JS 4/24/88



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	HEAT TREAT	DRN	LLW	DATE 4/23/88	 DANIELS MANUFACTURING CORP. ORLANDO, FLORIDA CASE 11851
FINISH	APPL	WJP	DATE 4/22/88	TITLE	
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